

# SGM72003 High Linearity SP3T RF Switch

## GENERAL DESCRIPTION

The SGM72003 is a single-pole/triple-throw (SP3T) antenna switch, which supports from 0.1GHz to 3GHz. The device features low insertion loss and high isolation, which makes it suitable for high linearity receiving application. It also has the advantage of high linearity performance. The SGM72003 is not subject to cellular interference and is applied to multi-mode and multi-band LTE mobile phones.

The SGM72003 has the ability to integrate SP3T RF switch and GPIO controller on an SOI chip. Internal driver and decoder for switch control signals are offered by the GPIO controller, which makes it flexible in RF path band and routing selection.

No external DC blocking capacitors required on the RF paths as long as no external DC voltage is applied, which can save PCB area and cost.

The SGM72003 is available in a Green UTQFN-1.1×1.1-9L package.

## **APPLICATIONS**

2G/3G/4G Receiving

## **FEATURES**

- Supply Voltage Range: 2.4V to 3V
- **GPIO Controller**
- Operating Frequency Range: 0.1GHz to 3GHz
- Low Insertion Loss: 0.5dB (TYP) at 2.7GHz
- High Isolation: 20dB (MIN) at 2.7GHz
- Advanced Silicon-On-Insulator (SOI) Process
- No External DC Blocking Capacitors Required
- Available in a Green UTDFN-1.1×1.1-9L Package

## **BLOCK DIAGRAM**

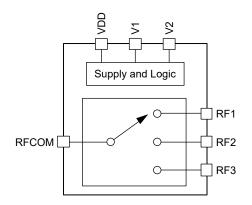


Figure 1. SGM72003 Block Diagram

## PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION	
SGM72003	UTQFN-1.1×1.1-9L	-40°C to +85°C	SGM72003YURK9G/TR	J0	Tape and Reel, 5000	

#### MARKING INFORMATION

NOTE: Fixed character for J0.

YY Serial Number

Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

## **ABSOLUTE MAXIMUM RATINGS**

Supply Voltage, V <sub>DD</sub>	3.3V
Control Voltage (V1 and V2 Pins), V <sub>CTL</sub>	3V
RF Input Power, P <sub>IN</sub>	27dBm
Junction Temperature	+150°C
Storage Temperature Range	55°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM	1000V

## **RECOMMENDED OPERATING CONDITIONS**

Operating Temperature Range	40°C to +85°C
Operating Frequency Range	0.1GHz to 3GHz
Supply Voltage, V <sub>DD</sub>	2.4V to 3V
Control High Voltage, V <sub>CTL_H</sub>	1.35V to 3V
Control Low Voltage, V <sub>CTL</sub> L	0V to 0.4V

#### **OVERSTRESS CAUTION**

Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.

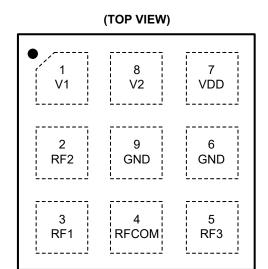
#### **ESD SENSITIVITY CAUTION**

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

#### **DISCLAIMER**

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

# **PIN CONFIGURATION**



UTQFN-1.1×1.1-9L

# **PIN DESCRIPTION**

PIN	NAME	FUNCTION
1	V1	DC Control Voltage 1
2	RF2	RF Port 2.
3	RF1	RF Port 1.
4	RFCOM	RF Common Port.
5	RF3	RF Port 3.
6, 9	GND	Ground.
7	VDD	DC Power Supply.
8	V2	DC Control Voltage 2.

# **LOGIC TRUTH TABLE**

VDD	V1	V2	ACTIVE PATH
Н	Н	L	RFCOM to RF1
Н	Н	Н	RFCOM to RF2
Н	L	Н	RFCOM to RF3
Н	L	L	Isolation

# **ELECTRICAL CHARACTERISTICS**

 $(V_{DD} = 2.4 \text{V to } 3\text{V}, T_A = +25^{\circ}\text{C}, P_{IN} = 0 \text{dBm}, 50\Omega, \text{ typical values are at } V_{DD} = 2.8 \text{V}, \text{ unless otherwise noted.})$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
DC Specifications	•			•		•
Supply Voltage	$V_{DD}$		2.4	2.8	3	V
Supply Current	I <sub>DD</sub>			32	65	μA
Control Voltage	$V_{\text{CTL\_H}}$	High	1.35	1.8	3	V
Control Voltage	V <sub>CTL_L</sub>	Low	0		0.4	7 v
Control Current	I <sub>CTL</sub>	V <sub>CTL</sub> = 0V		3	7	μA
Switching Time	t <sub>SW</sub>	50% of control voltage to 90% of RF power		1	2	μs
Turn-On Time	t <sub>ON</sub>	Time from V <sub>DD</sub> = 0V to part on and RF at 90%		5	10	μs
RF Specifications						
		0.1GHz to 1.0GHz		0.30	0.42	
Insertion Loss (RFCOM to All RF Ports)	IL	1.0GHz to 2.0GHz		0.40 0.62	0.62	dB
(		2.0GHz to 2.7GHz	1.35	0.50	0.72	
		0.1GHz to 1.0GHz	30	35		
Isolation (RFCOM to All RF Ports)	ISO	1.0GHz to 2.0GHz	24	30		dB
( 55 157 1 1 1 1 1 1 1 1 1		2.0GHz to 2.7GHz	20	25		
		0.1GHz to 1.0GHz		25		
Input Return Loss (RFCOM to All RF Ports)	RL	1.0GHz to 2.0GHz		24		dB
(ru com to rui ru roto)		2.0GHz to 2.7GHz		23		
0.1dB Compression Point (RFCOM to All RF Ports)	P <sub>0.1dB</sub>	0.1GHz to 3GHz		27		dBm
2 <sup>nd</sup> Harmonics	2f <sub>0</sub>	P <sub>IN</sub> = 26dBm, 0.1GHz to 3GHz		85		dBc
3 <sup>rd</sup> Harmonics	3f <sub>0</sub>	P <sub>IN</sub> = 26dBm, 0.1GHz to 3GHz		75		dBc

# TYPICAL APPLICATION CIRCUIT

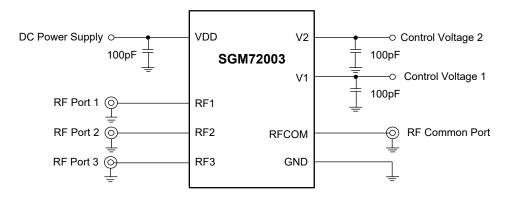


Figure 2. SGM72003 Typical Application Circuit

# **EVALUATION BOARD LAYOUT**

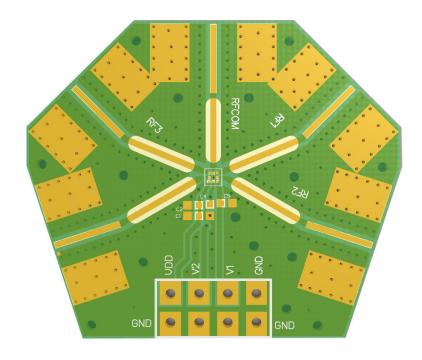


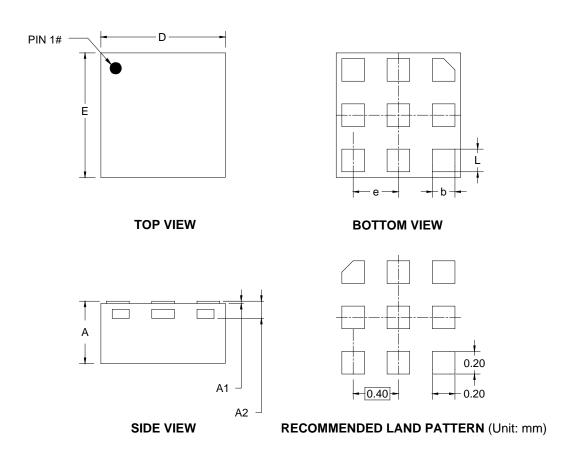
Figure 3. SGM72003 Evaluation Board Layout

## **REVISION HISTORY**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Original (MARCH 2022) to REV.A	Page
Changed from product preview to production data	All

# PACKAGE OUTLINE DIMENSIONS UTQFN-1.1×1.1-9L

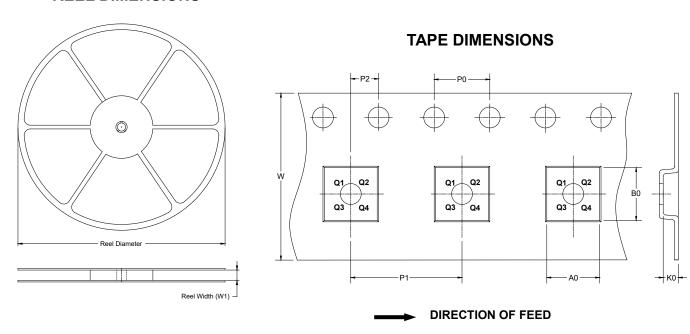


Symbol	Dimensions In Millimeters						
Symbol	MIN	MOD	MAX				
Α	0.500	0.550	0.600				
A1	0.000	0.020	0.050				
A2	0.152 REF						
D	1.000	1.100	1.200				
E	1.000	1.100	1.200				
b	0.150	0.200	0.250				
е	0.350	0.400	0.450				
L	0.150	0.200	0.250				

NOTE: This drawing is subject to change without notice.

# TAPE AND REEL INFORMATION

## **REEL DIMENSIONS**

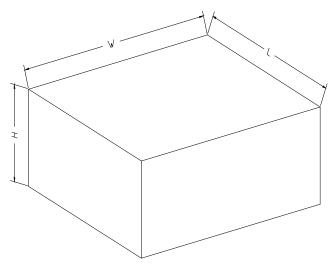


NOTE: The picture is only for reference. Please make the object as the standard.

## **KEY PARAMETER LIST OF TAPE AND REEL**

	Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
ι	JTQFN-1.1×1.1-9L	7"	9.5	1.30	1.30	0.69	4.0	4.0	2.0	8.0	Q2

## **CARTON BOX DIMENSIONS**



NOTE: The picture is only for reference. Please make the object as the standard.

## **KEY PARAMETER LIST OF CARTON BOX**

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
7" (Option)	368	227	224	8
7"	442	410	224	18